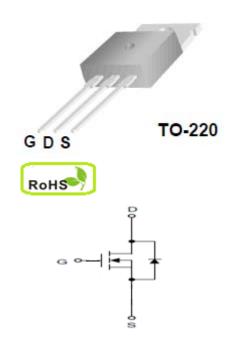
SKD492T 80V N-Channel MOSFET

■ FEATURES

- 80V/120A RDS(ON)= 6.5m**Ω typ**@ VGS=10V
- Lead free and Green Device Available
- Low Rds-on to Minimize Conductive Loss
- High avalanche Current
- Application
- Power Supply
- DC-DC Converters
- E-Bike

■ PIN DESCRIPTION



Absolute Maximum Ratings (T_A=25°C unless otherwise noted)

Symbol	Parameter		Maximum	Unit	
V_{DSS}	Drain-to-Source Voltage		80	V	
V_{GSS}	Gate-to-Source Voltage		±25	V	
I_D^3	Continuous Drain Current	T _C =25°C	120	A	
		T _C =100°C	80		
I_{DP}^4	Pulsed Drain Current	T _C =25°C	360	^	
IAS ⁵	Avalanche Current	·	25		
EAS⁵	Avalanche energy		300	mJ	
PD	Maximum Power Dissipation	T _C =25°C	195	- W	
		T _C =100°C	97		
T _{J.} T _{STG}	Junction & Storage Temperature Range		-55~175	°C	

Thermal Characteristics

Symbol	Parameter	Typical	Unit		
Rθjc	Thermal Resistance-Junction to Case	0.79	°C/\\/		
Rθja	Thermal Resistance-Junction to Ambient	62.5	°C/W		

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Electrical Characteristics (TA=25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Тур	Max.	Unit			
Static Characteristics									
BV_{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V,I _D =250uA	80	_	_	V			
	Zero Gate Voltage Drain Current	V _{DS} =64V,V _{GS} =0V	_		1	uA			
I _{DSS}		T _J =125°C	_	_	10				
$V_{GS(th)}$	Gate Threshold Voltage	V _{DS} =V _{GS} ,I _D =250uA	2	3	4	V			
I _{GSS}	Gate Leakage Current	V _{GS} =±25V, V _{DS} =0V	_	_	±100	nA			
D 1	Drain-Source On-Resistance	V _{GS} =10V, I _D =40A	_	6.5	7.5	mΩ			
R _{DS(on)} ¹				_	_				
Diode Characteristics									
V_{SD}^{1}	Diode Forward Voltage	I _{SD} =40A,V _{GS} =0V	_	_	1.3	V			
ls ³	Diode Continuous Forward Current		_	_	140	Α			
t _{rr}	Reverse Recovery Time	I _F =40A,	_	55	_	nS			
Q _{rr}	Reverse Recovery Charge	dI/dt=100A/us	_	100	_	nC			
Dynamic Characteristics ²									
R_G	Gate Resistance	V _{GS} =0V, V _{DS} =0V, Frequency=1MHz	_	1	_	Ω			
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =25V Frequency=1MHz		2700					
C _{oss}	Output Capacitance		_	540	_	pF			
C_{rss}	Reverse Transfer Capacitance		_	180	_				
$t_{d(on)}$	Turn-On Delay Time		_	23					
t_r	Rise Time	V_{DD} =40V, I_D =40A, V_{GS} =10V, R_G =6 Ω	_	41		nS			
$t_{d(off)}$	Turn-Off Delay Time		—	59					
t _f	Fall Time			19					
Gate Charge	Characteristics ²			•					
Q_g	Total Gate Charge	V _{DS} =64V,V _{GS} =10V		75	_				
Q_gs	Gate-to-Source Charge	-I _D =40A	_	12	—	nC			
Q_{gd}	Gate-to-Drain Charge	וטוע		28					

Note: 1: Pulse test; pulse width \leq 300us, duty cycle \leq 2%.

^{2:} Guaranteed by design, not subject to production testing.

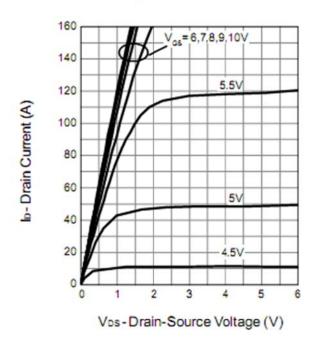
^{3:} Package limitation current is 55A.Calculated continuous current based on maximum allowable junction temperature.

^{4:} Repetitive rating, pulse width limited by max junction temperature.

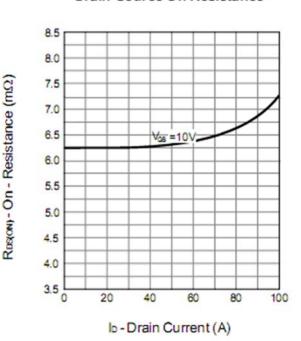
^{5:} Starting $TJ = 25^{\circ}C, L = 0.5mH, VDD=64V, IAS = 50A.$

Typical Operating Characteristics

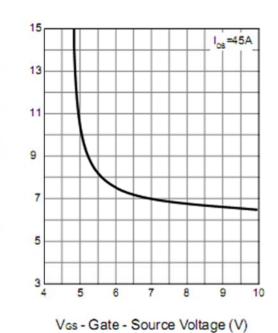
Output Characteristics



Drain-Source On Resistance

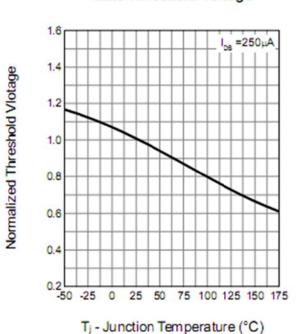


Drain-Source On Resistance



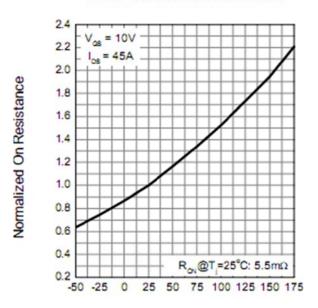
Rescon) - On - Resistance (mΩ)

Gate Threshold Voltage



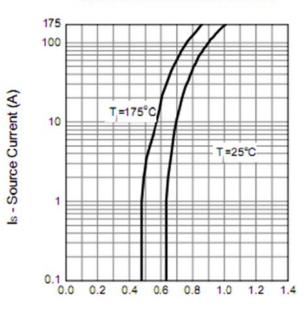
Typical Operating Characteristics

Drain-Source On Resistance



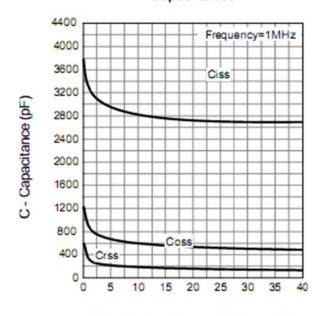
T_j-Junction Temperature (°C)

Source-Drain Diode Forward



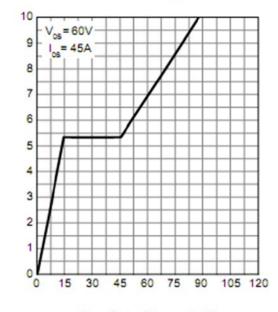
Vso - Source-Drain Voltage (V)

Capacitance



Vos - Drain - Source Voltage (V)

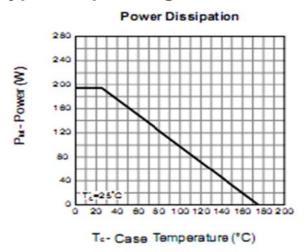
Gate Charge

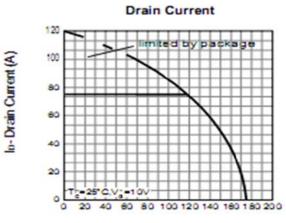


Qg - Gate Charge (nC)

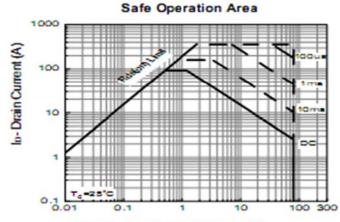
Vos - Gate-source Voltage (V)

Typical Operating Characteristics





Tc- Case Temperature (°C)



Vos - Drain - Source Voltage (V)

Thermal Transient Impedance

